GROUP 10 AUTOMATIC BREWER



COLLEGE OF ENGINEERING & COMPUTER SCIENCE

Robert Bower (EE)
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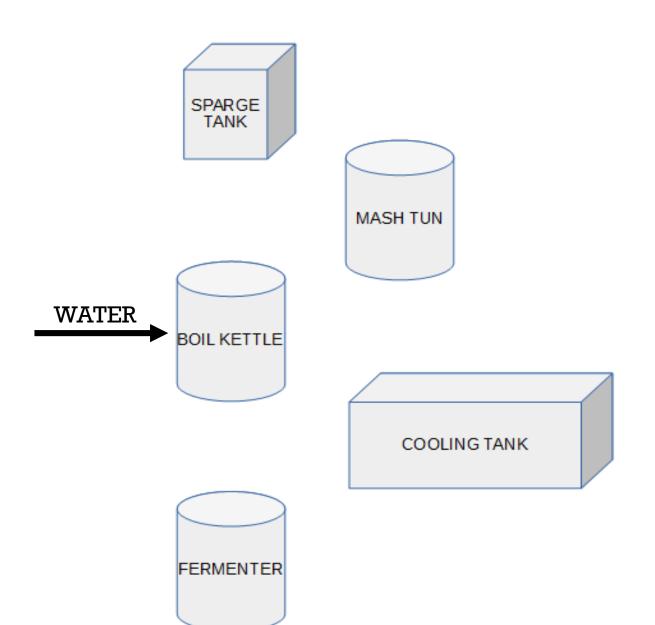


MAKING BEER

- Basic ingredients (water, barley, hops, and yeast)
- Process:
 - Step 1: Mash
 - Step 2: Sparge
 - Step 3: Boil
 - Step 4: Cool
 - Step 5: Fermentation

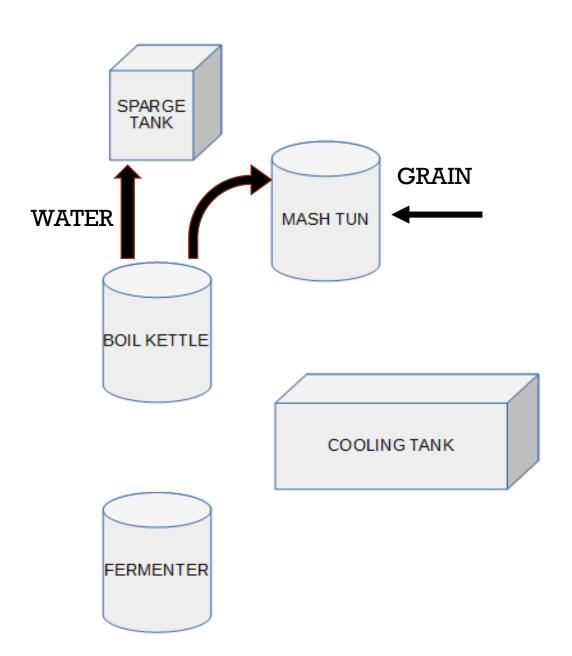


MASH



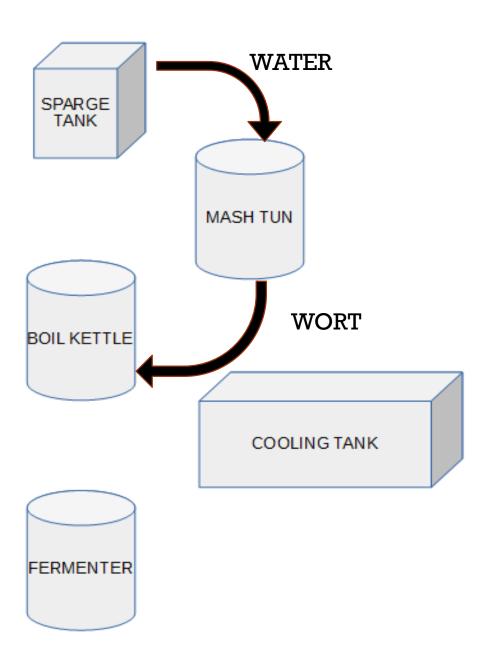


MASH



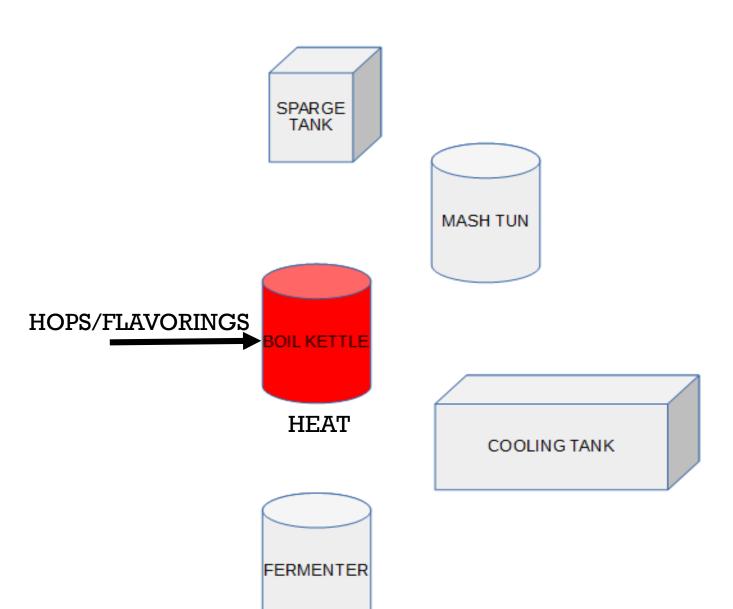


SPARCE



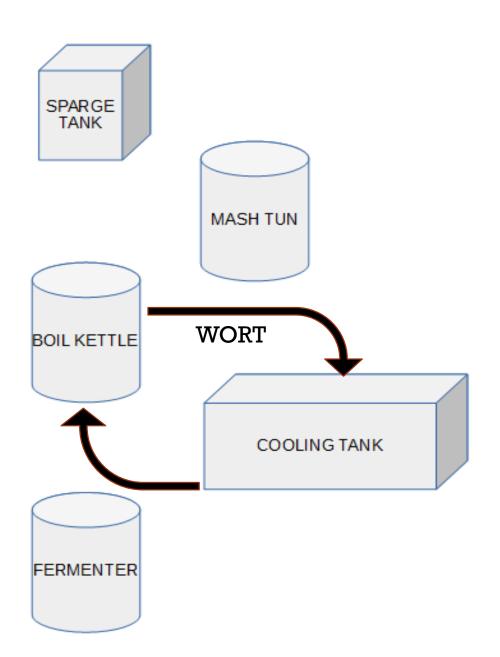


BOIL



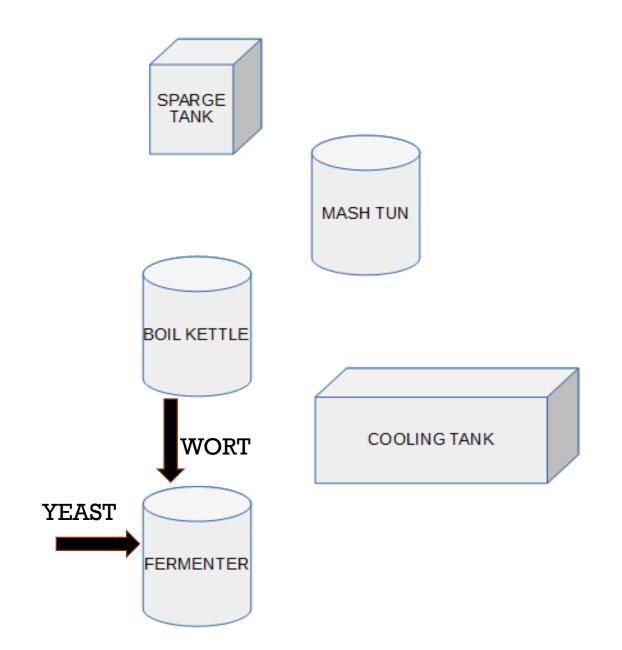


COOLING AND TRANSFER





COOLING AND TRANSFER





PROJECT GOALS

Automate wort making process

- Process:
 - Step 1: Mash
 - Step 2: Sparge
 - Step 3: Boil
 - Step 4: Cool
 - Step 5: Fermentation
- Data collection
- Provide supervisory control
- Add connectivity (Bluetooth, Wi-Fi)



REQUIREMENTS

- Provide accurate temperature control
- Provide fault detection within the system
- Provide fluid level control
- System must operate within user defined variables
- System must produce a safe, consumable product
- System must collect process data

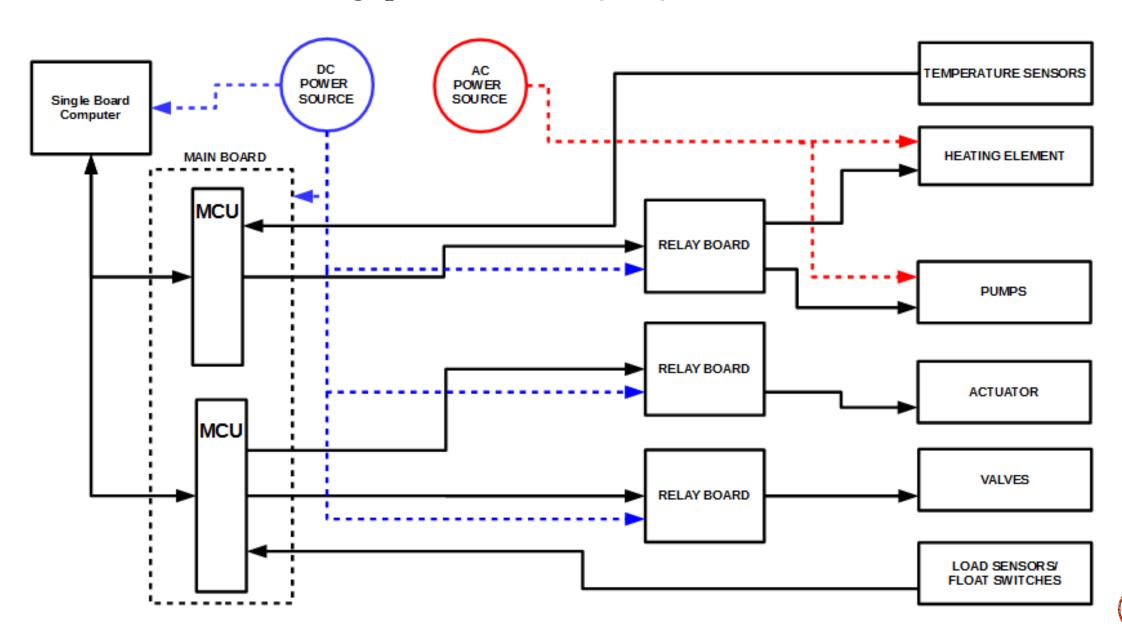


MOTIVATION

- Move focus towards process variables instead of the process
- Accurately document process variables
- Make process accurately repeatable



OVERALL SYSTEM

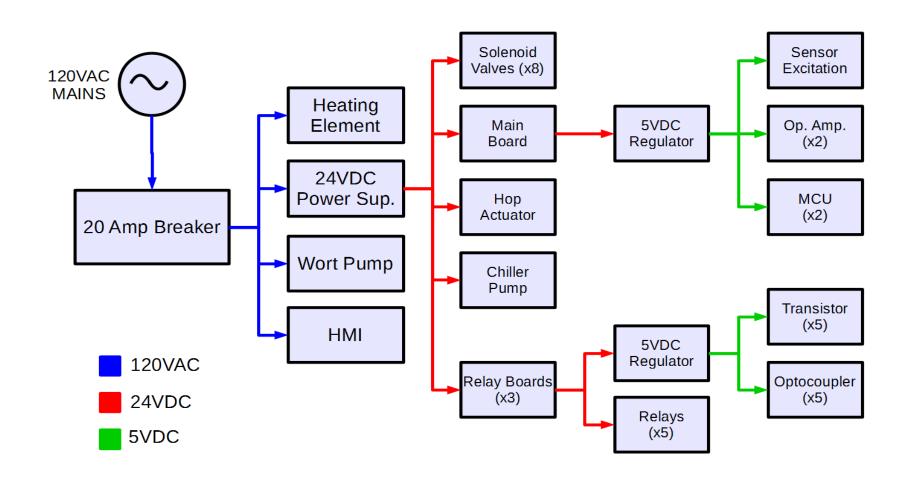


COMPONENTS AND POWER CONSUMPTION

COMPONENT	OPERATING VOLTAGE	POWER CONSUMPTION
Heating Element	120 VAC	1500 W
Wort Pump	120 VAC	160 W
HMI	120 VAC	100 W
Chiller Pump	24 VDC	20 W
Actuator	24 VDC	17 W
Solenoid Valve (x8)	24 VDC	7.2 W (57.6 W)
Slim Relays [low power] (x12)	24 VDC	0.2 W (2.4 W)
Relays [high power] (x3)	24VDC	0.8 W (2.4 W)
Relay Control Board (x3)	5 VDC	4.8W (14.4 W)
MCU/Main Board	5 VDC	10 W
TOTAL		~1900W



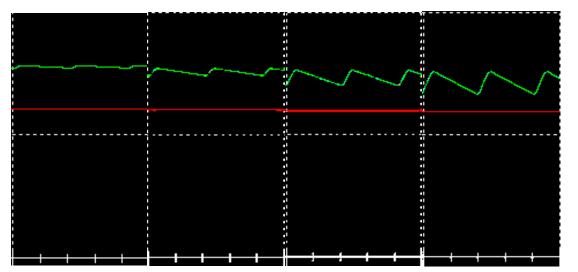
POWER DISTRIBUTION

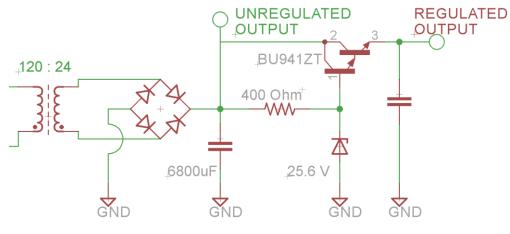




POWER DISTRIBUTION — PSU PERFORMANCE

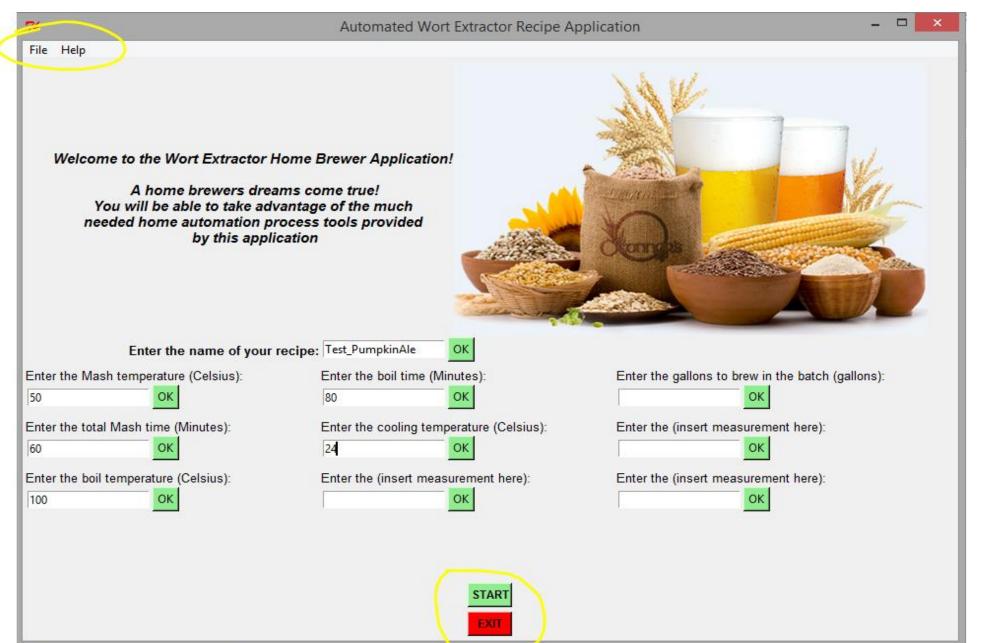
LOAD	REGULATED VOLTAGE	POWER OUTPUT	TRANSISTOR POWER DISSIPATION
Low – 0.5 Amps	24.21 V	12.1 W	4.5 W
Medium – 1.5 Amps	24.13 V	36.2 W	11 W
High – 3.5 Amps	23.95 V	83.8 W	23 W
MAX – 5.3 Amps	23.83 V	126.3 W	32 W







USER INTERFACE



USER INTERFACE (CONTD.)

Software Integration Diagram:

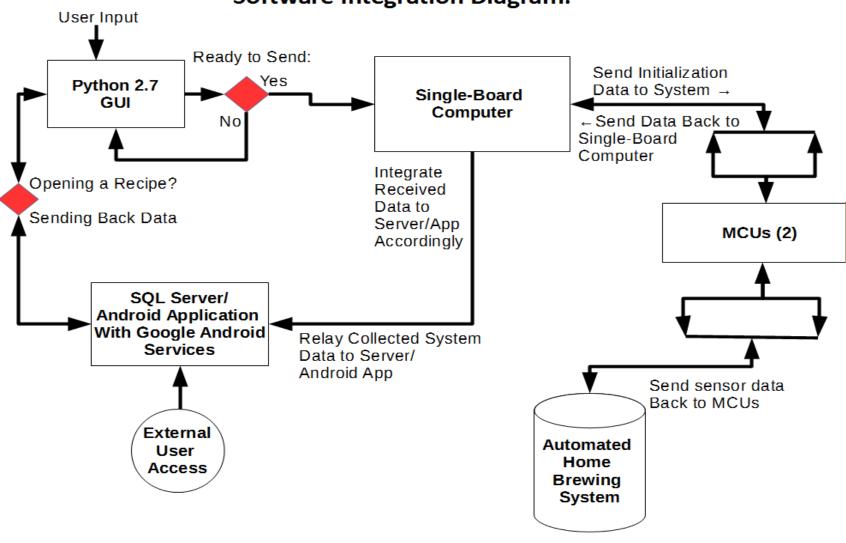




Table 4.6: Raspberry Pi B+VS. Other Modern Single Board Computer Models

(Information for Raspberry Pi courtesy of the Raspberry Pi Foundation, A13-OLinuXino Wi-Fi courtesy of Olimex, Cubieboard2 courtesy of the Element 14 Community, Banana Pi courtesy of Banana Pi)

Single Board Computer Name:	Raspberry Pi Model B+	A13-OLinuXino Wi-Fi Enabled	Cubieboard2	Banana Pi
Developer:	Raspberry Pi Foundation	Olimex	Cubieboard	LeMaker
Release Date:	Summer 2014	April 2012	November 2012	2014
Cost:	\$35.00	\$68.70	\$49.00	\$54.99
Processor:	ARM11	ARM Cortex-A8	ARM Cortex A7-Dual Core	ARM Cortex A7-Dual Core
SoC (Software on Chip):	Broadcom BCM2835	Allwinner A13	Allwinner A20	Allwinner A20
GPU:	Dual Core VideoCore IV	ARM Mali-400	ARM Mali-400	ARM Mali-400
Clock Speed:	700 MHz	1.0 GHz	2 x 1.0 GHz	$2 \times 1.0 \text{ GHz}$
RAM/Memory:	512MB SDRAM / None	512MB / 4GB NAND Flash	1GB DDR3 / 3.4GB NAND Flash	1GB DDR3 / None
OS Image (Linux/Android):	Linux	Android	Linux OR Android	Linux OR Android
Power Supply:	5V, 2A	6-16V (Battery supported)	5V, 1-2A	5V, 2A
GPIO Count:	27	8	-	7
I2C Support:	Yes	Yes	Yes	Yes
HDMI Port:	Yes	No	Yes	Yes
Ethernet Port:	Yes	No	Yes	Yes
USB Port(s):	4 hosts	4 hosts (3 for users)	2 hosts	2 hosts
Video/Audio Out:	Yes	Yes	Yes	Yes
Dimensions:	85mm x 56mm	120mm x 120 mm	100mm x 60mm	92mm x 60mm
Weight:	45g	n/a	n/a	48g

WHY THE RASPBERRY PI B+?

- 512MB RAM
- 700 MHz clock speed
- Runs Linux OS (Raspbian)
- The most affordable (\$35)
- Prior working knowledge of the Raspberry Pi models

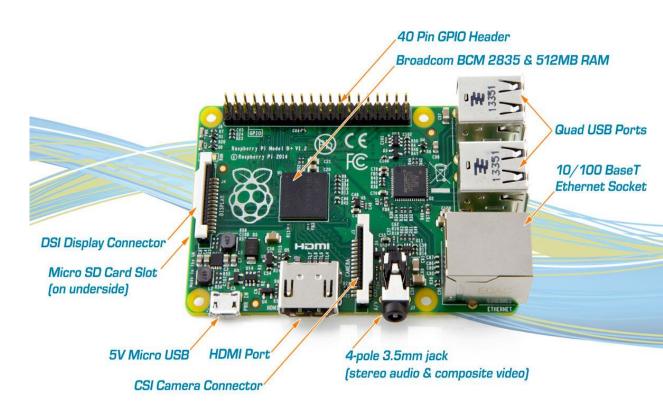


Image Courtesy of: Element 14 Community

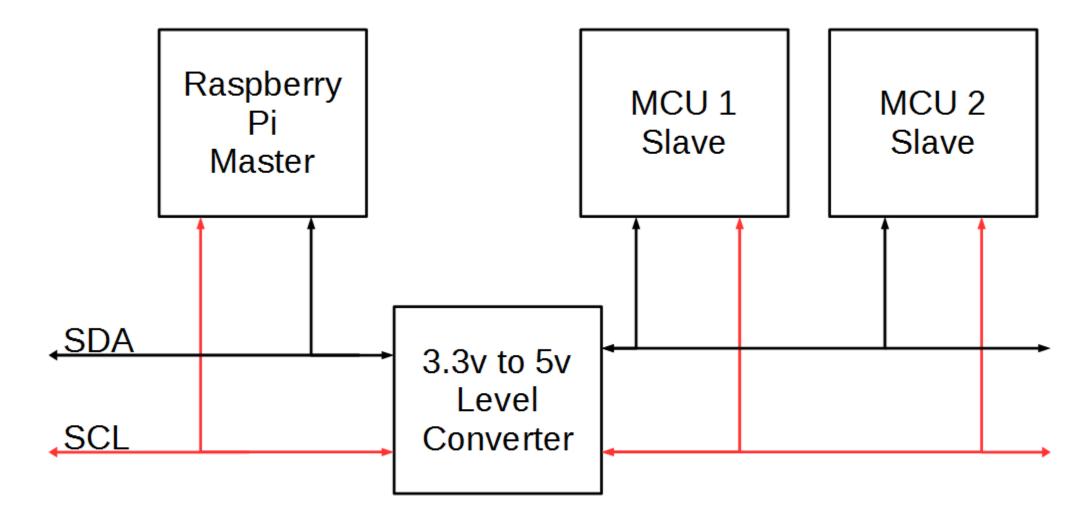


I²C COMMUNICATION

- Raspberry Pi (Master)
- Two MCU's (Slaves)
- 3.3V to 5V logic level converter
- 3 kHz Clock Rate

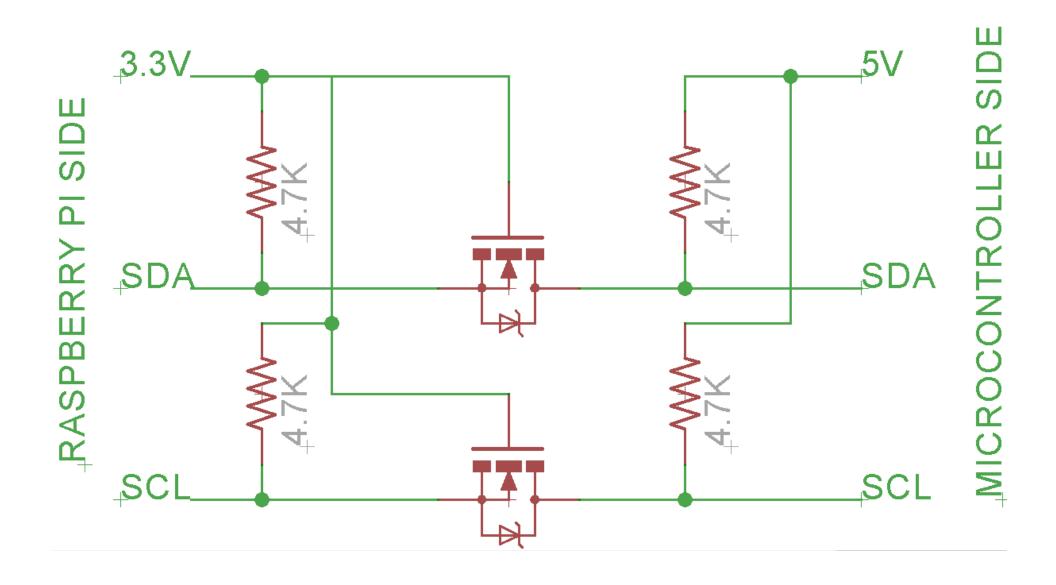


I²C BUS





LOGIC LEVEL CONVERTER



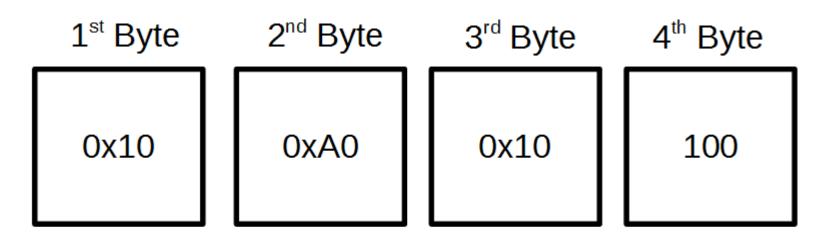


BUS CAPACITANCE CALCULATIONS

$$f_{SCL} \le 100 \ kHz$$
 $R_p = \frac{V_{cc} - 0.4}{3mA}$ $R_p = \frac{1000ns}{C_b}$



SENDING DATA TO MCU'S



1st Byte: 7 bit MCU address & R/W bit

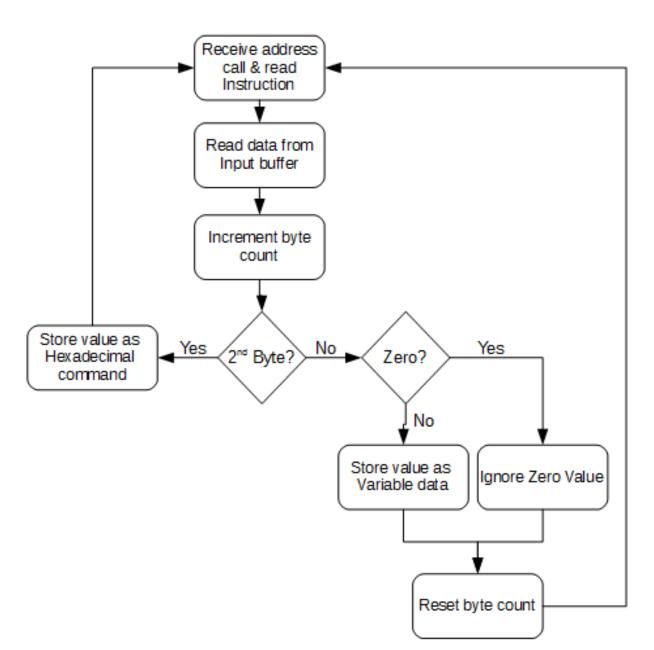
2nd Byte: Hexadecimal command

3rd Byte: 7 bit MCU address & R/W bit

4th Byte: Variable Data



READING DATA AT MCU'S





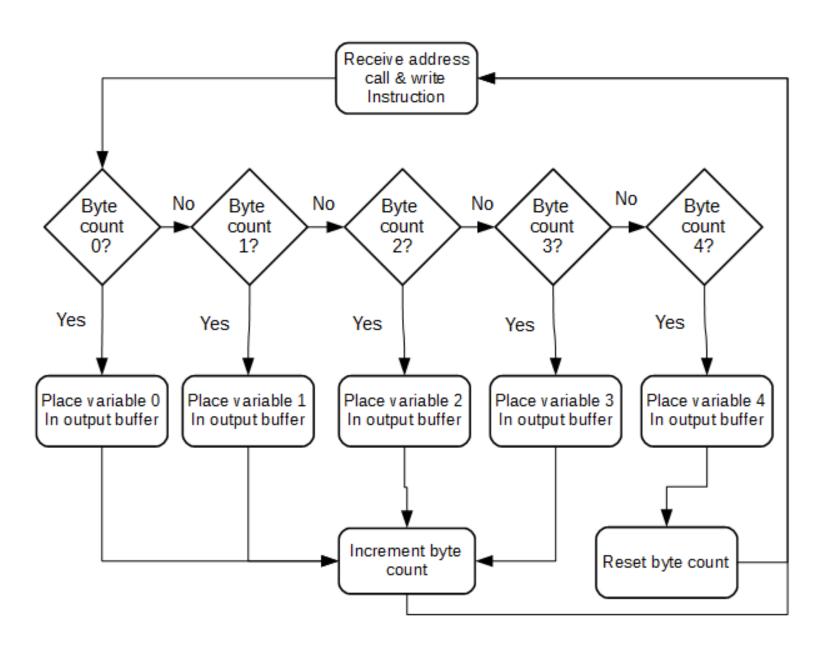
RETRIEVING DATA FROM MCU'S

1 Byte 0x10

7 bit MCU address & R/W bit



SENDING DATA FROM MCU'S





MICROCONTROLLER

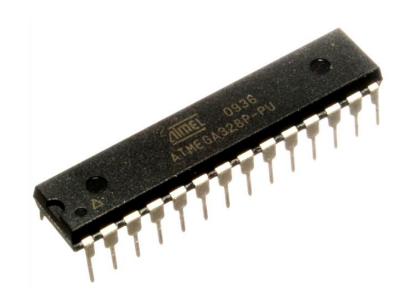
Requirements

- 5+ Analog to Digital Converters
- 13+ I/O Ports
- I²C Capability
- Large RAM and Program Memory Capacity
- 5V Operation
- DIP Packaging



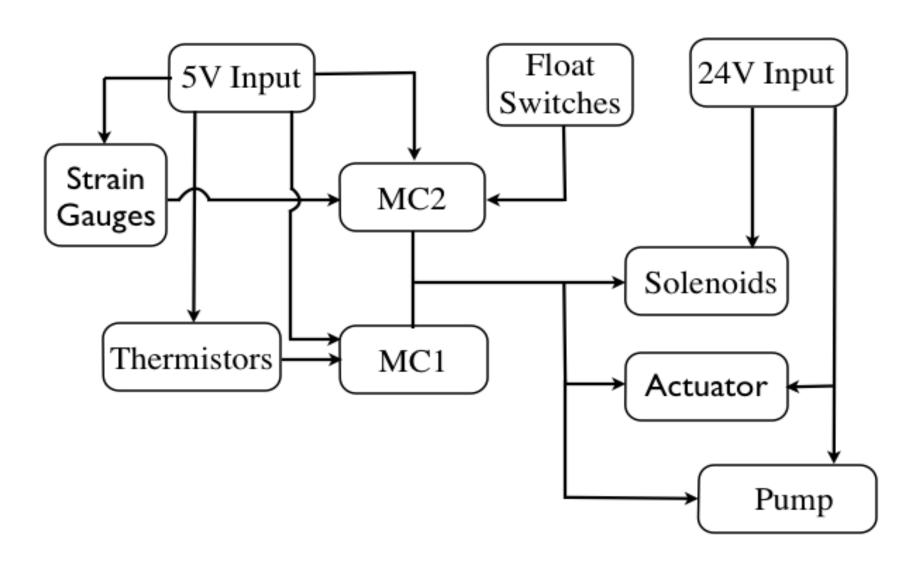
MICROCONTROLLER

Hardware Comparison of Select Microcontrollers				
	Texas Instruments MSP4302553	Freescale Semiconductor MC9S08SE8CRL	Microchip Technologies PIC16C73B	Atmel ATMEGA 328P-PU
Package	PDIP-20	PDIP-28	PDIP-28	PDIP-28
ADC Channels	8	10	5	6
ADC Bit Size	10	10	8	10
I/O	16	24	22	23
Communication	I ² C, UART, SPI, IrDA	SCI	I ² C, USART, SPI	I ² C, USART, SPI
Supply Voltage	1.8 - 3.6 V	2.7 - 5.5 V	4.0 - 5.5 V	1.8 - 5.5 V
Timers	2	2	3	3
RAM size	512 Byte	512 Byte	192 Byte	2 kByte
Program Memory	16 kByte	8 kByte	4 kByte	32 kByte
Max Clock Freq.	16 MHz	20 MHz	4 MHz	20 MHz



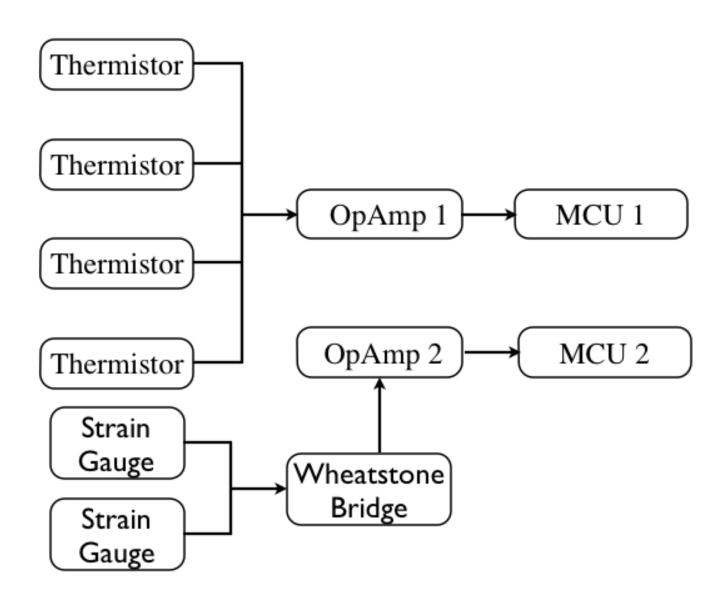


DATA ACQUISITION



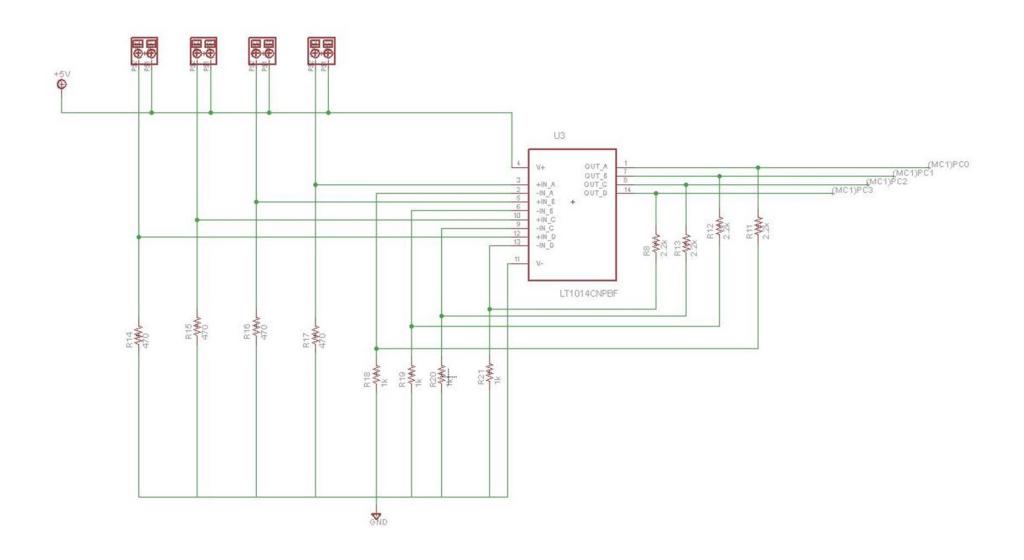


DATA ACQUISITION



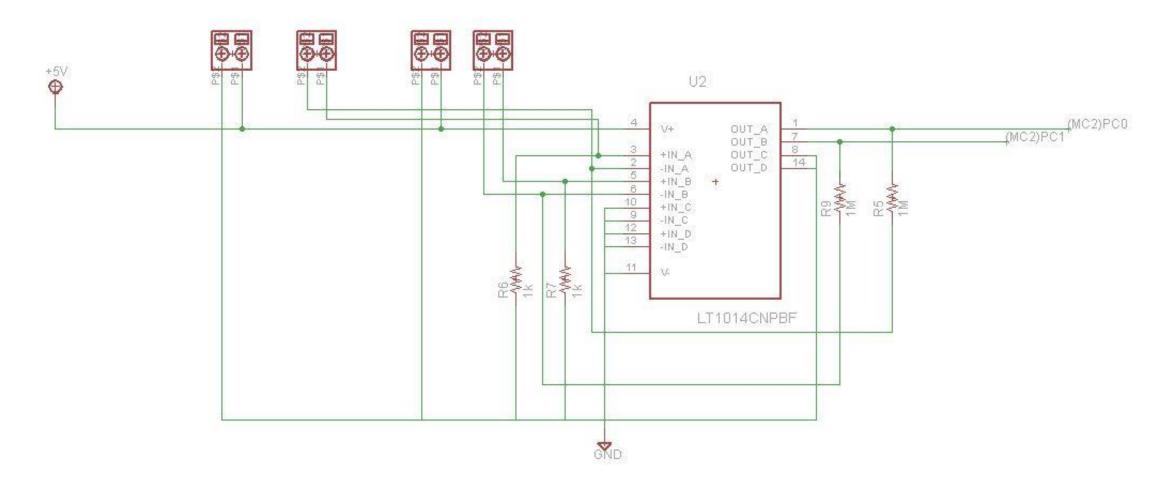


TEMPERATURE SENSOR CIRCUIT



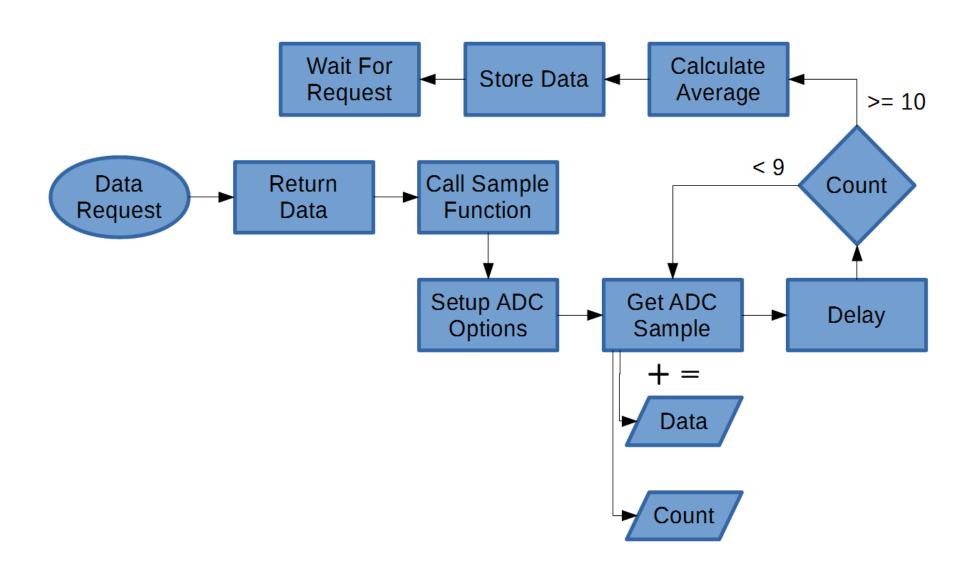


WEIGHT SENSOR CIRCUIT



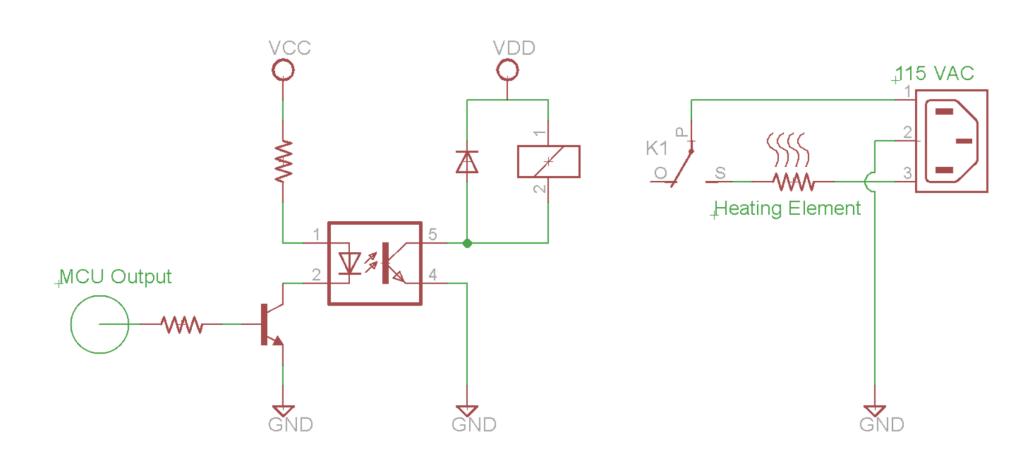


MICROCONTROLLER SAMPLE PROCESS



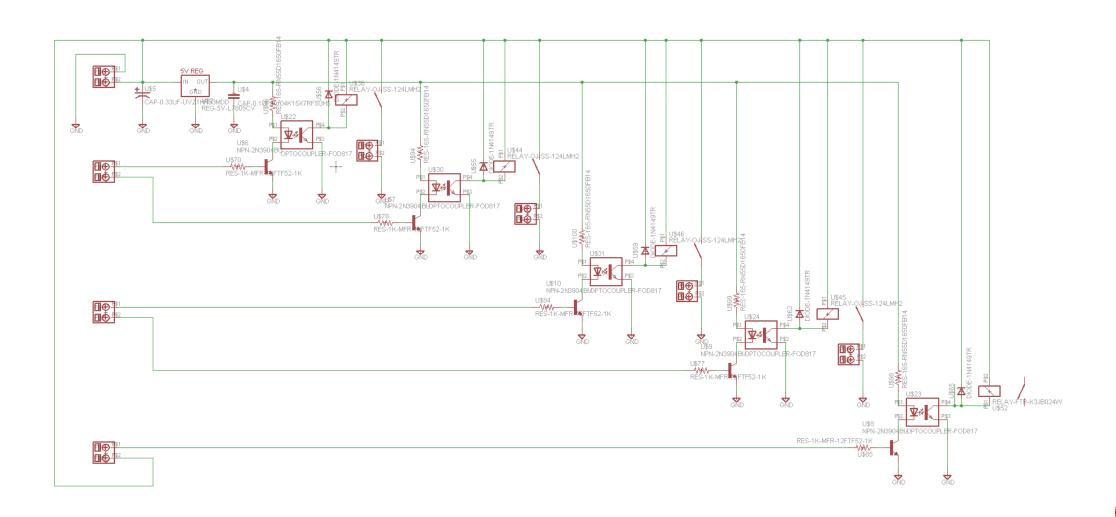


MICROCONTROLLER - SWITCHING HIGH POWER COMPONENTS

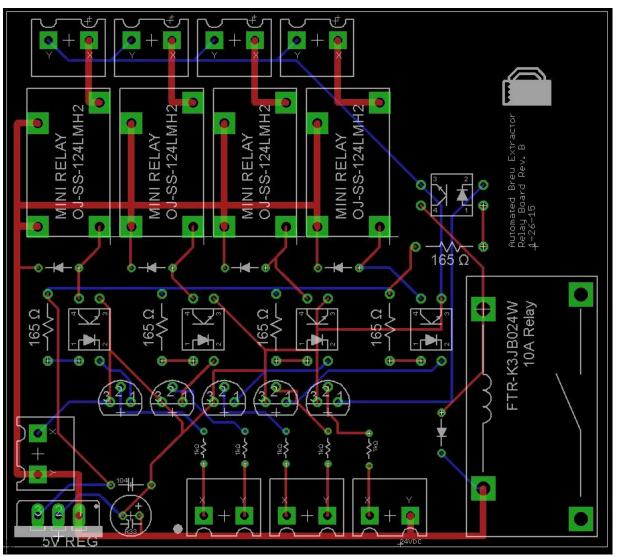


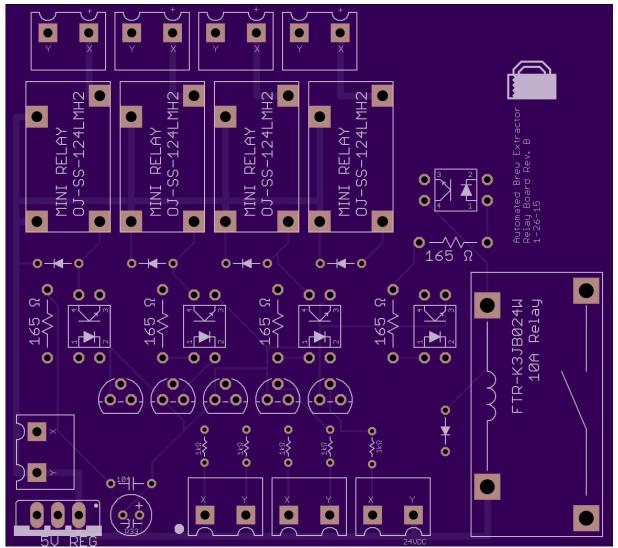


MICROCONTROLLER - SWITCHING HIGH POWER COMPONENTS

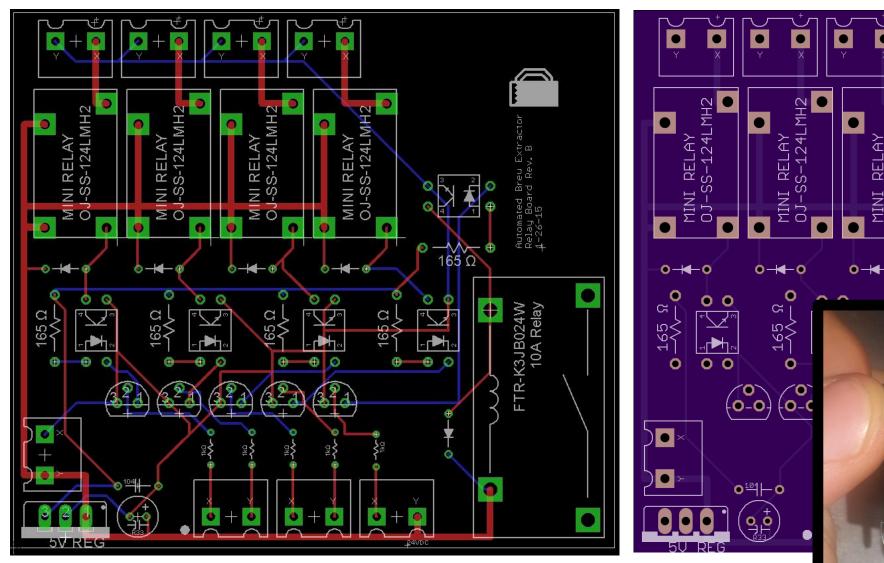


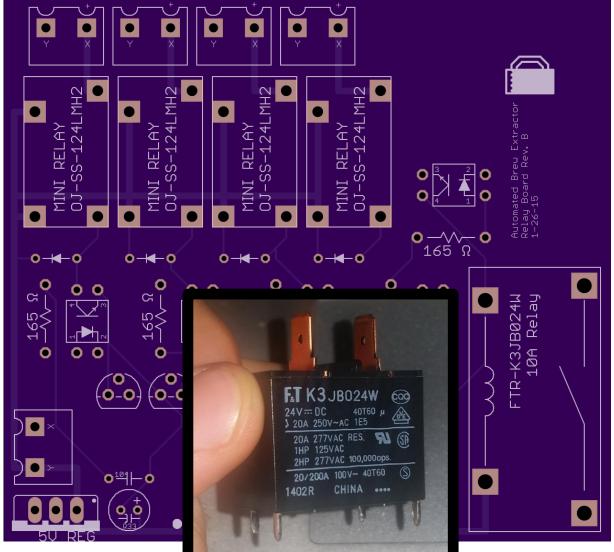






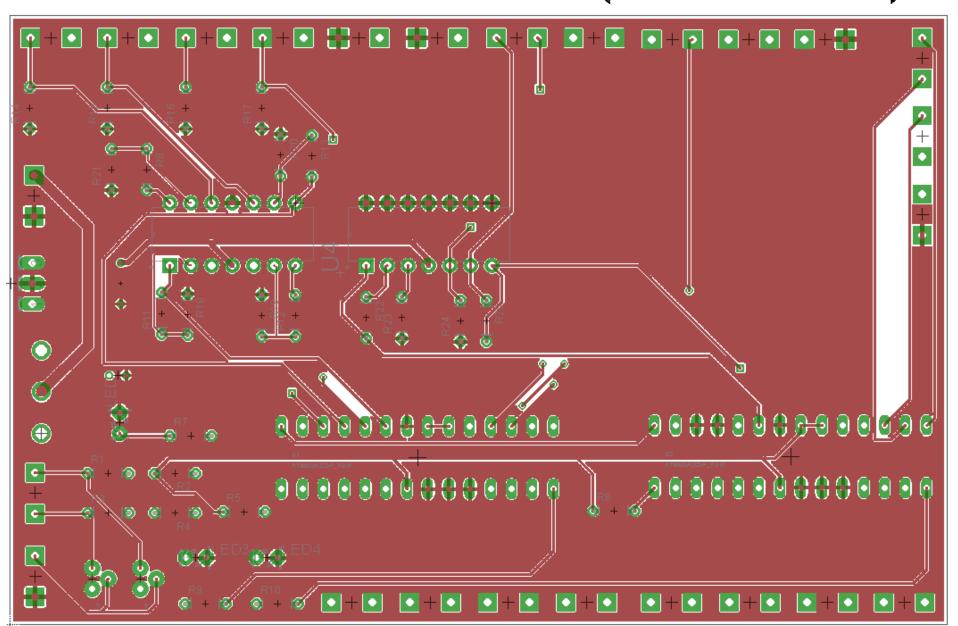






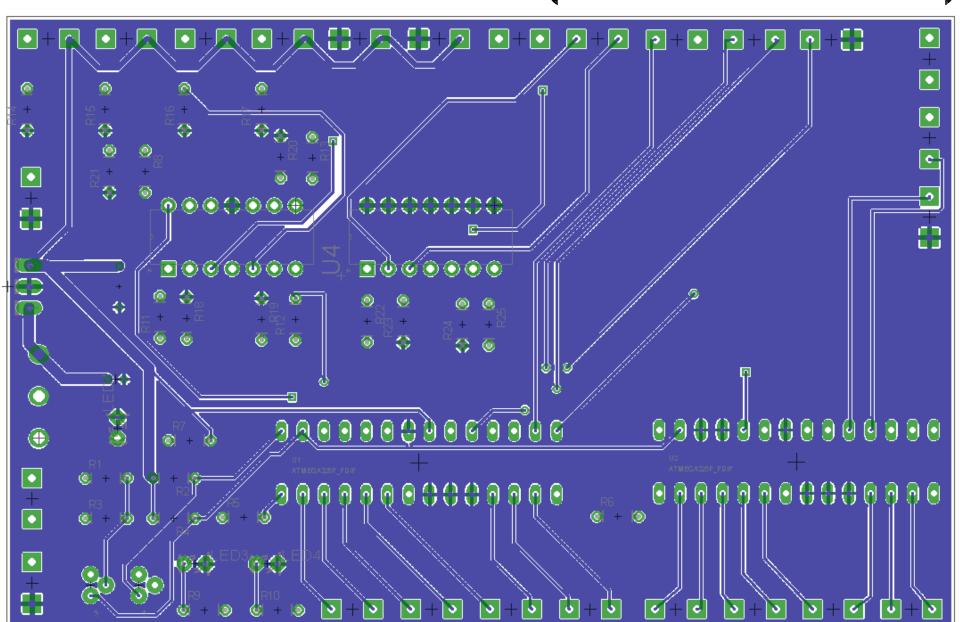


MAIN BOARD LAYOUT (TOP LAYER)



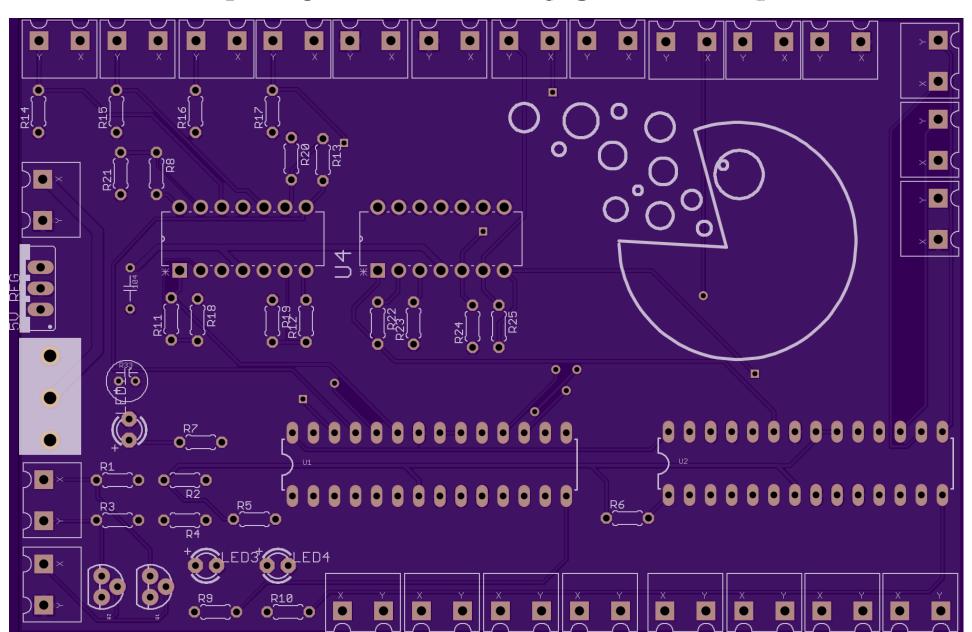


MAIN BOARD LAYOUT (BOTTOM LAYER)

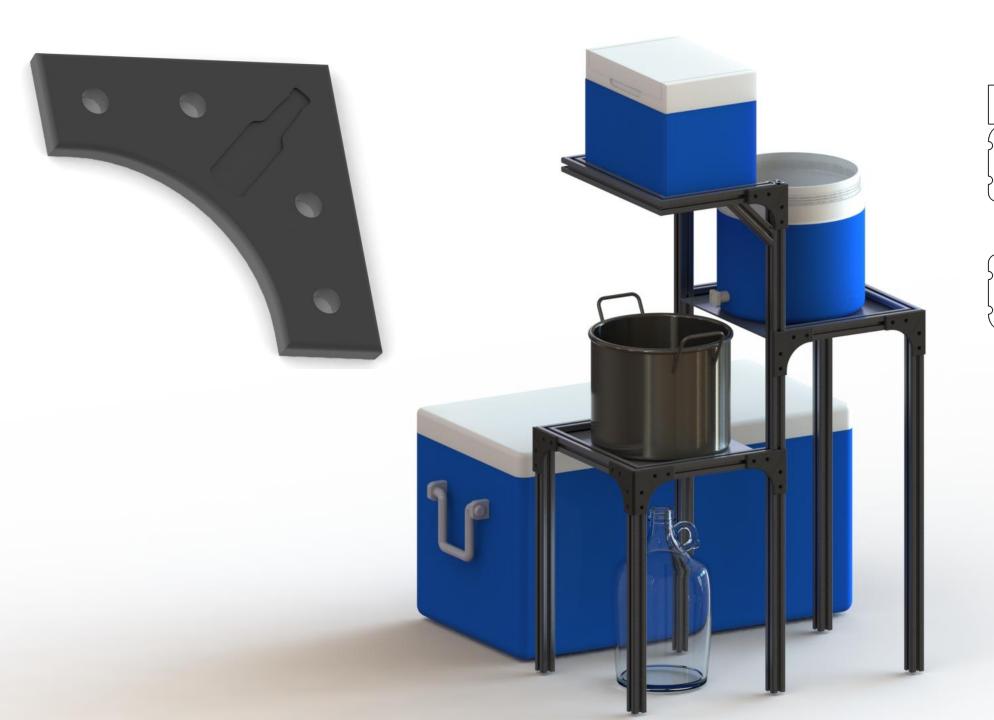


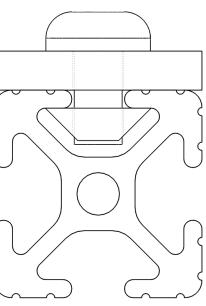


MAIN BOARD LAYOUT PRINTED









PROJECT SUCCESSES

- I²C communications working
- Switching of high power components working
- GUI input and data transfer working
- Achieved accurate and consistent temperature and weight measurement
- PCB design complete, ordered, and received



PROJECT DIFFICULTIES

- Increasing I²C clock rate
- Choosing power supply
- Fluctuations in 5v rail
- Oscillations in op-amp output



RESPONSIBILITIES

Group Member	Primary	Secondary	
Rob	Controls/Communication	UI	
Alonzo	Sensor Design/Programming	Structure Design	
David	User Interface	Data Logging	
Kleber	Sensor Design	Android App	

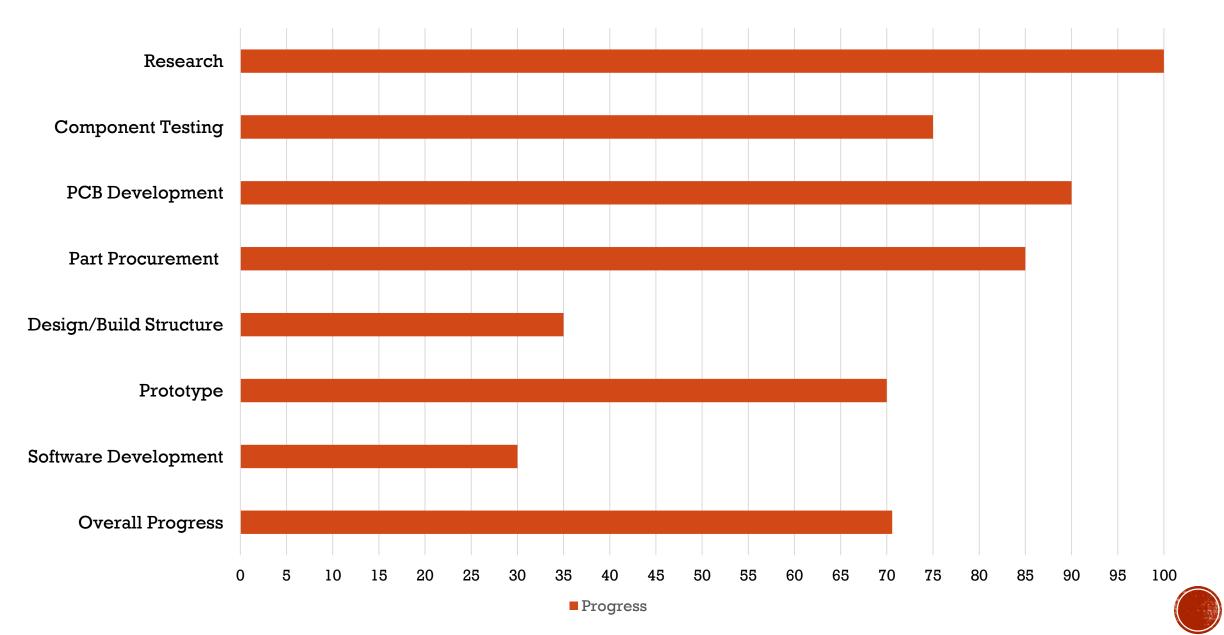


BUDGET

Item	Supplier		Spent	Budget
Structure				
Dunkelweizen Beer Kit	Brock's Hombrew		\$ 38.15	
Coleman 2-Gallon cooler	Walmart		\$ 14.70	
2 Gallon Stainless Steel Kettle	Northern Brewer		\$ 22.98	
l Gallon Clear Glass Carboy	Northern Brewer		\$ 27.95	
Solenoid Valve (x4)	eBay(valves4projects)		\$ 97.00	
Solenoid Valve (x4)	eBay(u-like-buy)		\$ 24.92	
Heat Exchanger	eBay(dudadiesl)		\$ 45.95	
Hose & Fittings	US Plastics		\$ 37.37	
SS NPT Barb Adapters	eBay(dailydeal*2013)		\$ 19.80	
Aluminum Extrusion & Hardware	Amazon (8020 Inc.)		\$ 124.57	
Coolers	Target		\$ 15.49	
		Subtotal	\$ 468.88	\$ 600.00
Electrical Components				
LT1014DN Op Amp(x2)	Linear Technology		\$ 24.80	
NTCAIMME3C90373(Thermistorx4)	Mouser Electronics		\$ 15.51	
Relay Board Components	Mouser Electronics		\$ 47.54	
Voltage Regulators & Caps	Mouser Electronics		\$ 23.98	
Terminal Blocks (x48)	eBay (szyuhua)		\$ 7.75	
PCB Relay Board Rev B	OSH Park		\$ 37.50	
Heating Element	Amazon		\$ 21.57	
Dip Socket	Newark		\$ 3.30	
Main Board Components	Newark		\$ 43.29	
PCB Main Board	Osh Park		\$ 65.43	
		Subtotal	\$ 290.67	\$ 400.00
		Total	\$ 759.55	\$ 1,000.00



CURRENT PROGRESS



MOVING FORWARD

- Complete the support structure
- Combine all system components
- Optimize system processes
- Android App
- Make beer

